

## **Discription**

The PESD12VL1BSLAZ protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. Excellent clamping capability, low leakage, low capacitance, and fast response time provide best in class protection on designs that are exposed to ESD.

It gives designer the flexibility to protect one bi-directional line in applications where arrays are not practical.



DFN1006-2L (SOD-882)

#### **Features**

- ★ Small Body Outline Dimensions: 1.00 mm x 0.60 mm
- ★ Low Body Height: 0.50 mm
- ★ Low Leakage
- ★ Response Time is Typically < 1 ns
- ★ ESD Rating of Class 3 per Human Body Model
- ★ IEC61000-4-2 Level 4 ESD Protection
- ★ We declare that the material of product compliance with RoHS requirements and Halogen Free.

# **○**

Circuit Diagram

## **Ordering information**

Product ID	Pack	Qty(PCS)
PESD12VL1BSLAZ	DFN1006-2L(SOD-882)	10000

## Absolute Ratings (T<sub>amb</sub>=25°C)

Symbol	Parameter		Value	Units
P <sub>PP</sub>	Peak Pulse Power ( $t_p = 8/20 \mu$ s)		140	W
TL	Maximum lead temperature for soldering during 10s		260	°C
T <sub>stg</sub>	Storage Temperature Range		-55 to +150	°C
$T_{op}$	Operating Temperature Range		-55 to +150	°C
Tj	Maximum junction temperature		150	°C
	IEC61000-4-2 (ESD)	air discharge	±20	KV
		contact discharge	$\pm 20$	

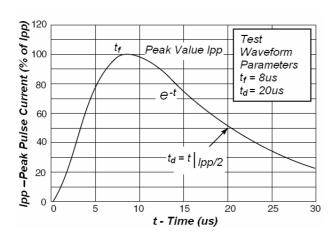


#### **Electrical Characteristics**

	V <sub>RWM</sub> (V)	I <sub>R</sub> (μΑ) @ V <sub>RWM</sub>	V <sub>BR</sub> (V	/) @ দ	I <sub>T</sub>	V <sub>C</sub> (V) @ lpp =8A	I <sub>PP</sub> (A)	P <sub>PK</sub> (W)	C (pF)
Device	Max	Max	Min	Max	mA	Max	Max	Max	Тур.
PESD12VL1BSLAZ	12	1	13.3	16	1.0	17	8	100	8

- 1.  $V_{BR}$  is measured with a pulse test current  $I_T$  at an ambient temperature of 25%.
- 2. Surge current waveform per Figure 1.

## Typical Performance Characteristics (T<sub>A</sub>=25°C unless otherwise Specified)



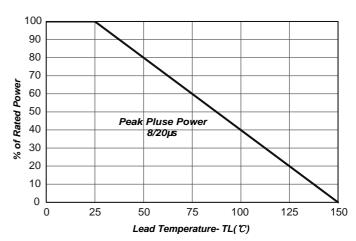


Fig1. Pulse Waveform

**Fig2.Power Derating Curve** 

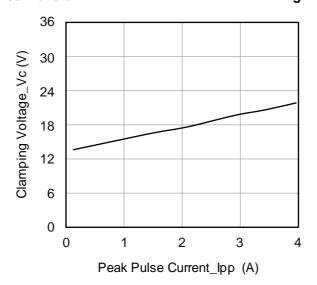
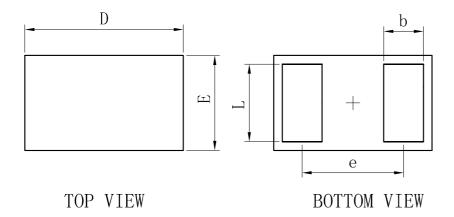
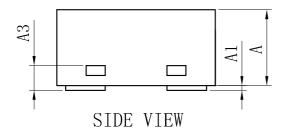


Fig 5.Clamping Voltage vs. Peak Pulse Current

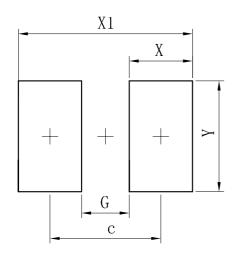
## **Outline and Dimensions**



DFN1006-2L(SOD-882)					
Dim	Min	Тур	Max		
D	0. 95	1.00	1.05		
Е	0. 55	0.60	0.65		
е	_	0.64	_		
L	0.44	0.49	0. 54		
b	0. 20	0. 25	0.30		
A	0. 43	0.48	0. 53		
A1	0	-	0.05		
A3	0. 127REF.				
All Dimensions in mm					



## **Soldering Footprint**



Dimensions	(mm)
С	0.70
G	0.30
X	0.40
X1	1. 10
Y	0.70

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